

ABSTRACT

An interconnect device for electrically interconnecting two components is disclosed. According to various embodiments, the interconnect device includes a frame having an upper side and a lower side, a first plurality of beam contacts on the upper side for connection to contacts of the first component, and a second plurality of contacts on the lower side of the frame for connection to contacts of the second component. The beam contacts on the upper side of the frame are arranged so that the sum of the sideways wipe forces caused by compression of the beam contacts on the upper side due to connection of the first component to the interconnect device approximately equals zero.